Form **PTO-1595** (Rev. 03-05) OMB No. 0651-0027 (exp. 6/30/2005)

103359237

United	States	Patent	and	Tra	demark	Offi
U.	S. DEF	AKIM	EIN I	Οr	COMIN	בתי

_	_

7

PATENTS	SONLY			
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) be	low.		
Name of conveying party(ies):	2. Name and address of receiving party(ies)			
Wen-Kun YANG	Advanced Chip Engineering Technolo	одуО		
	Internal Address:	S		
Additional name(s) of conveying party(ies) attached? Yes X No	Street Address:			
3. Nature of conveyance/Execution Date(s):	1	2963		
Execution Date(s): December 15, 2006	No. 65, Guangfu N. Rd., Hukou Township	112		
X Assignment Merger Change of Name				
Security Agreement Joint Research Agreement	City: Hsinchu County			
Government Interest Assignment	State:			
Executive Order 9424, Confirmatory License	Country: Taiwan ROC Zip: 303 Additional name(s) & address(es) Yes X No	_		
Other	Additional name(s) & address(es) Yes X No	5		
4. Application or patent number(s): A. Patent Application No.(s) NEW	This document is being filed together with a new applicatio B. Patent No.(s)	n.		
Additional numbers attached	6. Total number of applications and	_		
concerning document should be mailed: Name:loe McKinney Muncy	patents involved:			
Name: Joe McKinney Muncy BIRCH, STEWART, KOLASCH & BIRCH, LLP Internal Address: Atty. Dkt.: 5275-0124PUS1 Street Address: 8110 Gatehouse Road Suite 100 East P.O. Box 747	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00 Authorized to be charged by credit card Authorized to be charged to deposit account X Enclosed None required (government interest not affecting	ng title)		
City: Falls Church	8. Payment Information			
State: VA Zip: 22040-0747	a. Credit Card Last 4 Numbers			
Phone Number: (703) 205-8026	Expiration Date			
Fax Number: (703) 205-8050	b. Deposit Account Number			
Email Address: mailroom@bskb.com	Authorized User Name			
9. Signature: Signature	January 3, 2007			
Joe McKinney Muncy - 32,334 Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:	3		

01/04/2007 CNGUYENE 00000085 11548787 04 FC:8021 40.00 0F

Birch, Stewart, Kolasch & Birch, LLP

KM/smt

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

	Application No. NEW Filed January 3, 2007						
Insert Name(s) of Inventor(s)	***(Given Name FAMILY NAME (ALL CAPS))***						
	WHEREAS, Wen-Kun YANG						
	(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in						
Insert Title of Invention	Wafer Level Package with Die Receiving Through-Hole and Method of the Same						
	for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).						
Insert Date of Signing of Application	on						
Insert Name of Assignee	WHEREAS, Advanced Chip Engineering Technology Inc.						
insert Address of Assignee	of No. 65, Guangfu N. Rd., Hukou Township, Hsinchu County 303, Taiwan, R.O.C.						
CHECK BOX F APPROPRIATE	its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and in any foreign countries.						
	NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;						
	and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or						

terms for which the same may be granted.

Page 1 of 2

PATENT REEL: 018755 FRAME: 0303



Attorney Docket No. 5275-0124PUS1

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Dec 15, 2006

RECORDED: 01/03/2007

Name of Inventor (signature) Wen-Kun YANG

Page 2 of 2

February 2002

REEL: 018755 FRAME: 0304